Silicon PNP Epitaxial

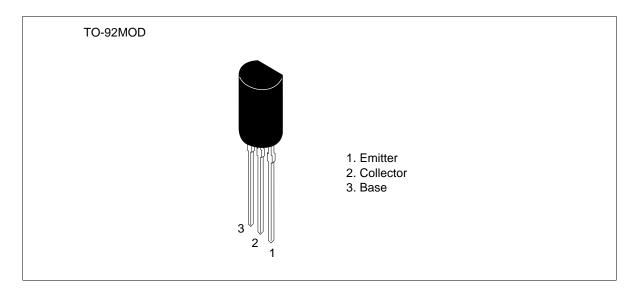
HITACHI

ADE-208-1027A (Z) 2nd. Edition Mar. 2001

Application

• Low frequency high voltage amplifier

Outline





Absolute Maximum Ratings (Ta = 25°C)

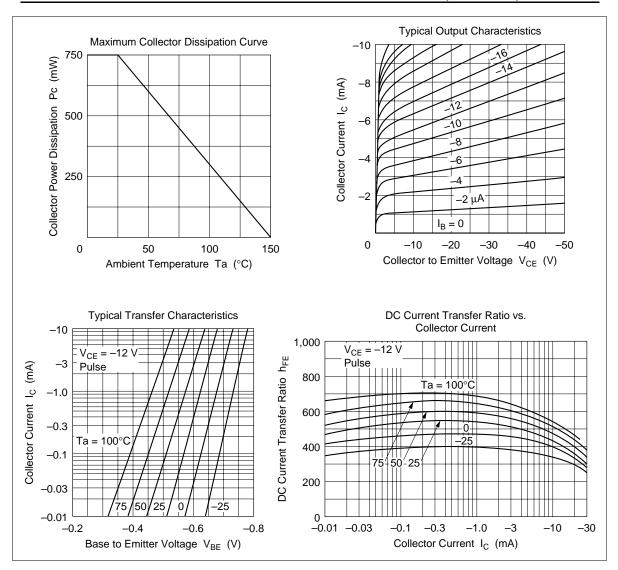
Item	Symbol	2SB715	2SB716	2SB716A	Unit
Collector to base voltage	V_{CBO}	-100	-120	-140	V
Collector to emitter voltage	V _{CEO}	-100	-120	-140	V
Emitter to base voltage	V _{EBO}	– 5	- 5	- 5	V
Collector current	I _c	-50	-50	- 50	mA
Collector power dissipation	P _c	750	750	750	mW
Junction temperature	Tj	150	150	150	°C
Storage temperature	Tstg	-55 to +150	-55 to +150	-55 to +150	°C

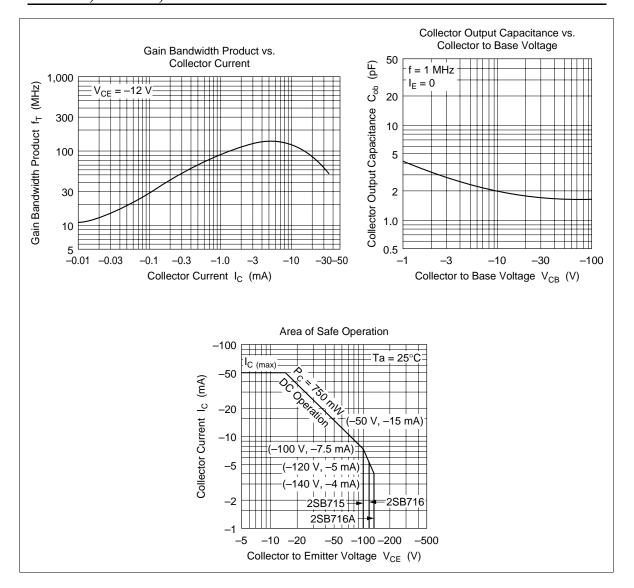
Electrical Characteristics ($Ta = 25^{\circ}C$)

		2SB7	2SB715 2SB716		2SB716A							
Item	Symbol	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	-100	_	_	-120	_	_	-140	_	_	V	$I_{C} = -10 \ \mu\text{A}, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-100	_	_	-120	_	_	-140	_	-	٧	$I_{C} = -1 \text{ mA},$ $R_{BE} = \infty$
Collector cutoff current	I _{CBO}	_	_	-0.5	_	_	_	_	_	_	μΑ	$V_{CB} = -80 \text{ V}, I_{E} = 0$
		_	_	_	_	_	-0.5	_	_	-0.5	μΑ	$V_{CB} = -100 \text{ V}, I_{E} = 0$
DC current transfer ratio	h _{FE1} *1	250	_	800	250	_	800	250	_	500		$V_{CE} = -12 \text{ V},$ $I_{C} = -2 \text{ mA}$
	h _{FE2}	125	_	_	125	_	_	125	_	_		$V_{CE} = -12 \text{ V},$ $I_{C} = -10 \text{ mA}$
Base to emitter voltage	V_{BE}	_	_	-0.75	_	_	-0.75	_	_	-0.75	V	$V_{CE} = -12 \text{ V},$ $I_{C} = -2 \text{ mA}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	-0.2	_	_	-0.2	_	_	-0.2	V	$I_C = -10 \text{ mA},$ $I_B = -1 \text{ mA}$
Gain bandwidth product	f _T	_	150	_	_	150	_	_	150	_	MHz	$V_{CE} = -12 \text{ V},$ $I_{C} = -5 \text{ mA}$
Collector output capacitance	Cob	_	1.8	_	_	1.8	_	_	1.8	_	pF	$V_{CB} = -25 \text{ V}, I_{E} = 0,$ f = 1 MHz

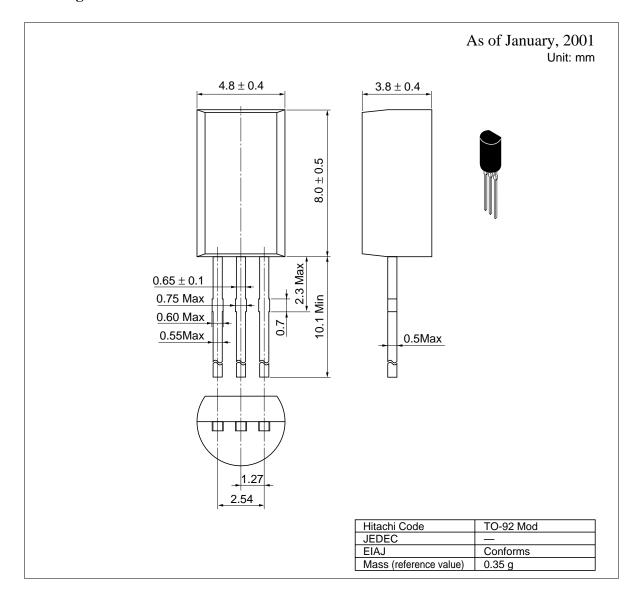
Note: 1. The 2SB715, 2SB716 and 2SB716A are grouped by h_{FE1} as follows.

	D	E
2SB715, 2SB716	250 to 500	400 to 800
2SB716A	250 to 500	_





Package Dimensions



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